# Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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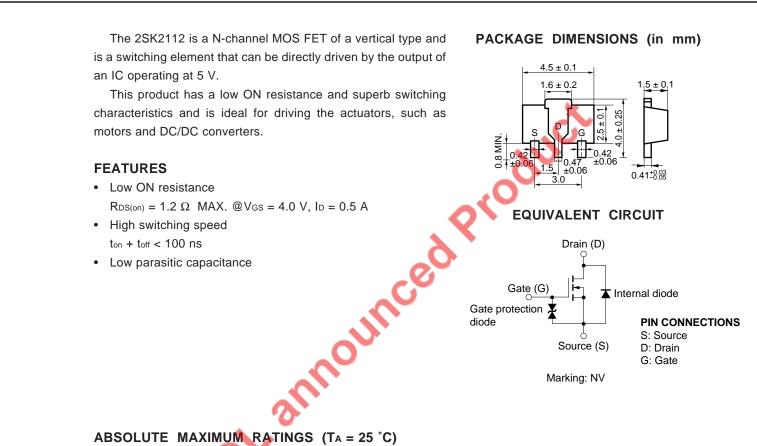
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# RENESAS

# **MOS FIELD EFFECT TRANSISTOR** 2SK2112

## N-CHANNEL MOS FET FOR HIGH-SPEED SWITCHING



		- 25 0)		
PARAMETER	SYMBOL	TEST CONDITIONS	RATING	_
Drain to Source Voltage	Vdss	V <sub>GS</sub> = 0	100	
Gate to Source Voltage	Vgss	Vds = 0	±20	1
Drain Current (DC)	D(DC)		±1.0	1
Drain Current (Pulse)	D(pulse)	$PW \le 10 \text{ ms},$ Duty cycle $\le 50 \%$	±2.0	
Total Power Dissipation	Р⊤	16 cm <sup>2</sup> $\times$ 0.7 mm, ceramic substrate used	2.0	
Channel Temperature	Tch		150	
Storage Temperature	Tstg		–55 to +150	

UNIT V V А А

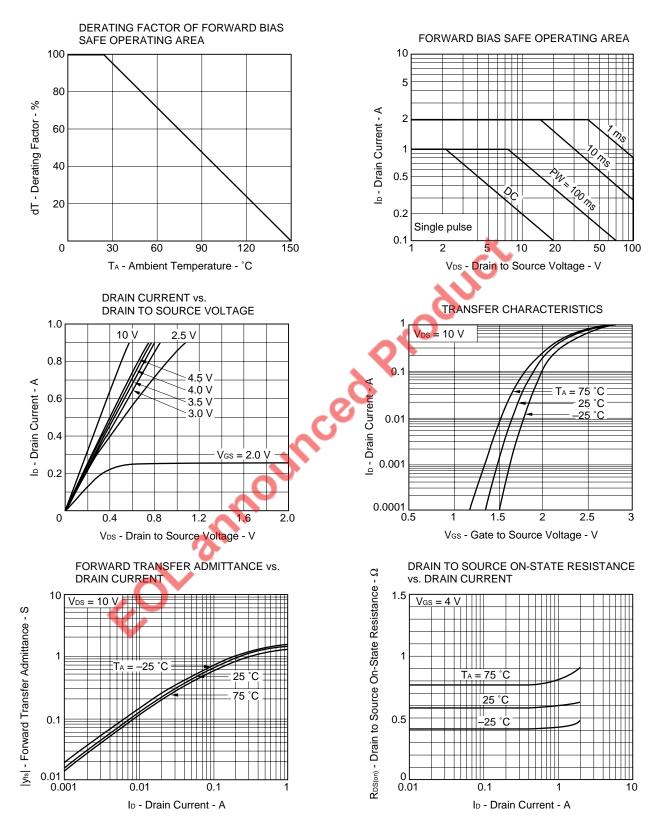
> W °C

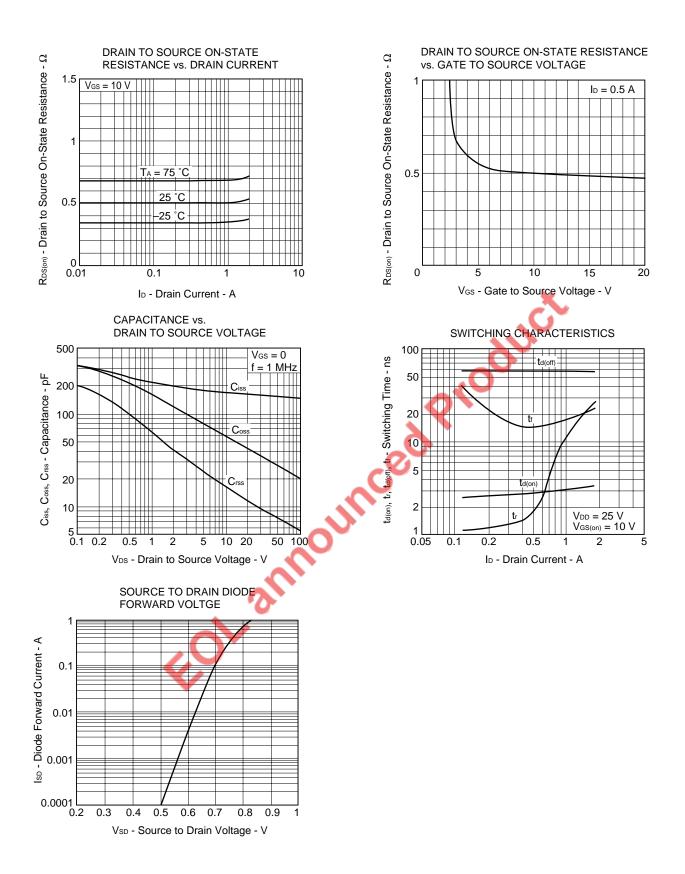
°C

### ELECTRICAL CHARACTERISTICS ( $T_A = 25$ °C)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Cut-Off Current	IDSS	$V_{DS} = 100 V, V_{GS} = 0$			1.0	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ Vds} = 0$			±10	μΑ
Gate Cut-Off Voltage	VGS(off)	VDS = 10 V, ID = 1 mA	0.8	1.5	2.0	V
Forward Transfer Admittance	y <sub>fs</sub>	Vds = 10 V, Id = 0.5 A	0.4			S
Drain to Source On-State Resistance	RDS(on)1	Vgs = 4.0 V, Id =0.5 A		0.58	1.2	Ω
Drain to Source On-State Resistance	RDS(on)2	Vgs = 10 V, Id = 0.5 A		0.50	0.8	Ω
Input Capacitance	Ciss	$V_{DS} = 10 V, V_{GS} = 0,$		178		pF
Output Capacitance	Coss	f = 1.0 MHz		59		pF
Reverse Transfer Capacitance	Crss			16		pF
Turn-On Delay Time	td(on)	VDD = 25 V, ID = 0.5 A		2.9		ns
Rise Time	tr	$V_{GS(on)} = 10 \text{ V}, \text{ Rg} = 10 \Omega$		1.7		ns
Turn-Off Delay Time	td(off)	RL = 50 Ω		60		ns
Fall Time	tr			15		ns







### REFERENCE

Document Name	Document No.		
NEC semiconductor device reliability/quality control system	TEI-1202		
Quality grade on NEC semiconductor devices	IEI-1209		
Semiconductor device mounting technology manual	C10535E		
Guide to quality assurance for semiconductor devices	MEI-1202		
Semiconductor selection guide	X10679E		

tot announced product

[MEMO]

NEC

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Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices in "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact NEC Sales Representative in advance.

Anti-radioactive design is not implemented in this product.

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